

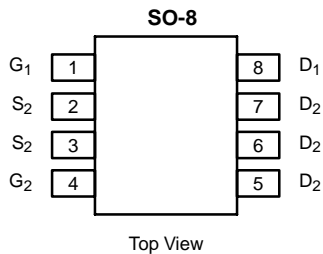


Dual N-Channel 30-V (D-S) MOSFET with Schottky Diode

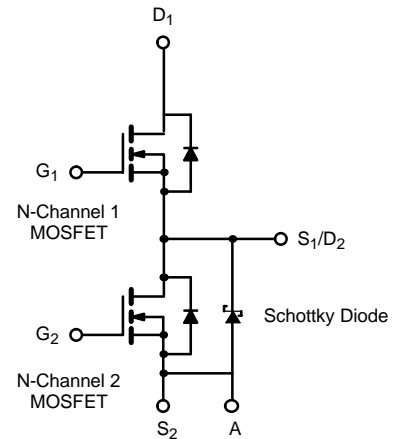
PRODUCT SUMMARY			
	V_{DS} (V)	$r_{DS(on)}$ (Ω)	I_D (A)
Channel-1	30	0.022 @ $V_{GS} = 10$ V	6.3
		0.030 @ $V_{GS} = 4.5$ V	5.4
Channel-2		0.013 @ $V_{GS} = 10$ V	10
		0.0185 @ $V_{GS} = 4.5$ V	8.6

LITTLE FOOT PLUS™

SCHOTTKY PRODUCT SUMMARY		
V_{DS} (V)	V_{SD} (V) Diode Forward Voltage	I_F (A)
30	0.50 V @ 1.0 A	2.0



Ordering Information: Si4816DY
Si4816DY-T1 (with Tape and Reel)



ABSOLUTE MAXIMUM RATINGS ($T_A = 25^\circ\text{C}$ UNLESS OTHERWISE NOTED)							
Parameter	Symbol	Channel-1		Channel-2		Unit	
		10 secs	Steady State	10 secs	Steady State		
Drain-Source Voltage	V_{DS}	30				V	
Gate-Source Voltage	V_{GS}	20					
Continuous Drain Current ($T_J = 150^\circ\text{C}$) ^a	I_D	$T_A = 25^\circ\text{C}$	6.3	5.3	10	7.7	A
		$T_A = 70^\circ\text{C}$	5.4	4.2	8.2	6.2	
Pulsed Drain Current	I_{DM}	30		40		A	
Continuous Source Current (Diode Conduction) ^a	I_S	1.3	0.9	2.2	1.15		
Maximum Power Dissipation ^a	P_D	$T_A = 25^\circ\text{C}$	1.4	1.0	2.4	1.25	W
		$T_A = 70^\circ\text{C}$	0.9	0.64	1.5	0.8	
Operating Junction and Storage Temperature Range	T_J, T_{stg}	-55 to 150				$^\circ\text{C}$	

THERMAL RESISTANCE RATINGS									
Parameter	Symbol	Channel-1		Channel-2		Schottky		Unit	
		Typ	Max	Typ	Max	Typ	Max		
Maximum Junction-to-Ambient ^a	R_{thJA}	$t \leq 10$ sec	72	90	43	53	48	60	$^\circ\text{C/W}$
		Steady-State	100	125	82	100	80	100	
Maximum Junction-to-Foot (Drain)	R_{thJC}	51	63	25	30	28	35		

Notes
a. Surface Mounted on 1" x 1" FR4 Board.

MOSFET SPECIFICATIONS (T_J = 25 °C UNLESS OTHERWISE NOTED)							
Parameter	Symbol	Test Condition	Min	Typ ^a	Max	Unit	
Static							
Gate Threshold Voltage	V _{GS(th)}	V _{DS} = V _{GS} , I _D = 250 μA	Ch-1	0.8		V	
			Ch-2	1.0			
Gate-Body Leakage	I _{GSS}	V _{DS} = 0 V, V _{GS} = 20 V	Ch-1		100	nA	
			Ch-2		100		
Zero Gate Voltage Drain Current	I _{DSS}	V _{DS} = 24 V, V _{GS} = 0 V	Ch-1		1	μA	
			Ch-2		100		
		V _{DS} = 24 V, V _{GS} = 0 V, T _J = 85 °C	Ch-1		15		
			Ch-2		2000		
On-State Drain Current ^b	I _{D(on)}	V _{DS} = 5 V, V _{GS} = 10 V	Ch-1	20		A	
			Ch-2	30			
Drain-Source On-State Resistance ^b	r _{DS(on)}	V _{GS} = 10 V, I _D = 6.3 A	Ch-1		0.018	0.022	Ω
		V _{GS} = 10 V, I _D = 10 A	Ch-2		0.0105	0.013	
		V _{GS} = 4.5 V, I _D = 5.4 A	Ch-1		0.024	0.030	
		V _{GS} = 4.5 V, I _D = 8.6 A	Ch-2		0.015	0.0185	
Forward Transconductance ^b	g _{fs}	V _{DS} = 15 V, I _D = 6.3 A	Ch-1		17	S	
		V _{DS} = 15 V, I _D = 10 A	Ch-2		28		
Diode Forward Voltage ^b	V _{SD}	I _S = 1.3 A, V _{GS} = 0 V	Ch-1		0.7	1.1	V
		I _S = 1 A, V _{GS} = 0 V	Ch-2		0.47	0.5	
Dynamic^a							
Total Gate Charge	Q _g	Channel-1 V _{DS} = 15 V, V _{GS} = 5 V, I _D = 6.3 A Channel-2 V _{DS} = 15 V, V _{GS} = 5 V, I _D = -10 A	Ch-1		8.0	12	nC
			Ch-2		15	23	
Gate-Source Charge	Q _{gs}		Ch-1		1.75		
			Ch-2		5.3		
Gate-Drain Charge	Q _{gd}		Ch-1		3.2		
			Ch-2		4.6		
Gate Resistance	R _g	Ch-1	1.5		6.1	Ω	
		Ch-2	0.5		2.6		
Turn-On Delay Time	t _{d(on)}	Channel-1 V _{DD} = 15 V, R _L = 15 Ω I _D ≅ 1 A, V _{GEN} = 10 V, R _G = 6 Ω Channel-2 V _{DD} = 15 V, R _L = 15 Ω I _D ≅ 1 A, V _{GEN} = 10 V, R _G = 6 Ω	Ch-1		10	20	ns
Rise Time	t _r		Ch-2		15	30	
			Ch-1		5	10	
Turn-Off Delay Time	t _{d(off)}		Ch-2		5	10	
			Ch-1		26	50	
Fall Time	t _f		Ch-2		44	80	
			Ch-1		8	16	
Source-Drain Reverse Recovery Time	t _{rr}		I _F = 1.3 A, di/dt = 100 A/μs	Ch-1		30	
		I _F = 2.2 A, di/dt = 100 μA/μs	Ch-2		32	70	

Notes

- a. Guaranteed by design, not subject to production testing.
 b. Pulse test; pulse width ≤ 300 μs, duty cycle ≤ 2%.

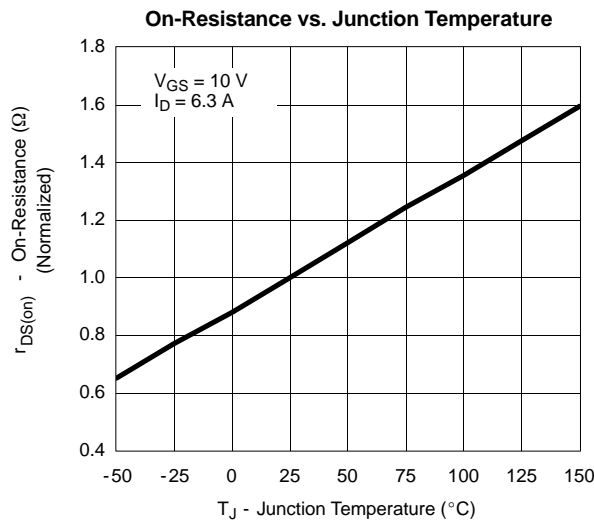
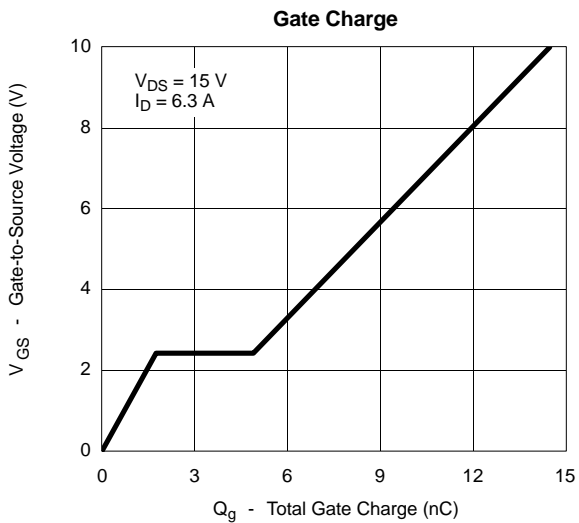
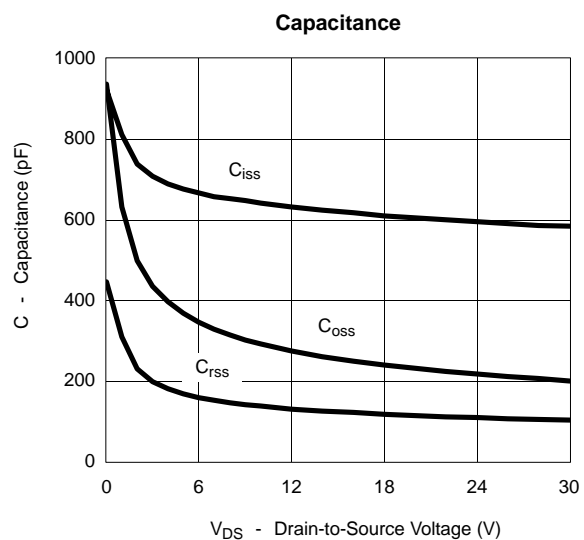
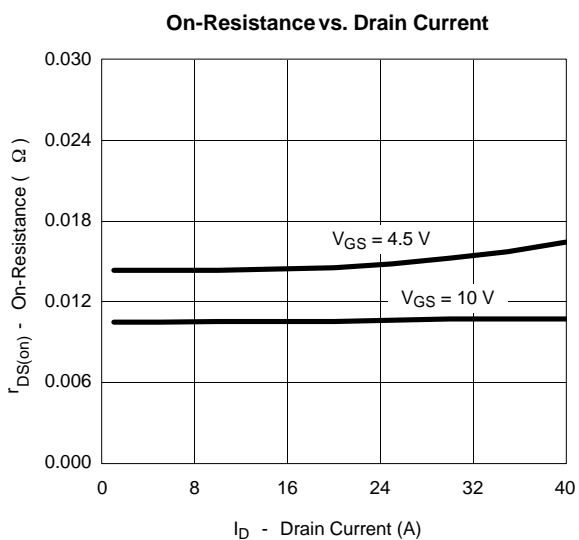
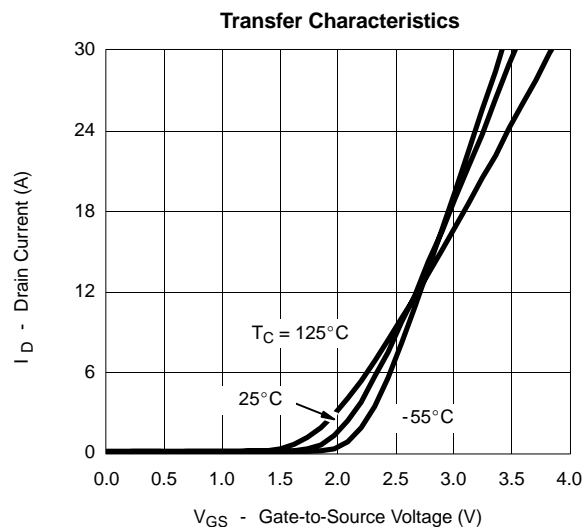
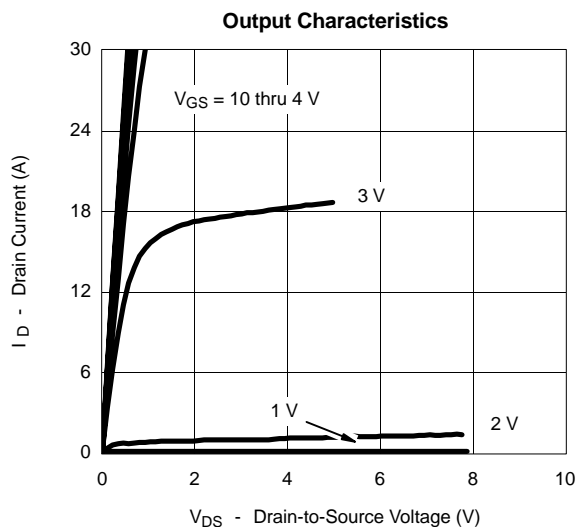
SCHOTTKY SPECIFICATIONS (T_J = 25 °C UNLESS OTHERWISE NOTED)						
Parameter	Symbol	Test Condition	Min	Typ	Max	Unit
Forward Voltage Drop	V _F	I _F = 1.0 A		0.47	0.50	V
		I _F = 1.0 A, T _J = 125 °C		0.36	0.42	



SCHOTTKY SPECIFICATIONS ($T_J = 25^\circ\text{C}$ UNLESS OTHERWISE NOTED)						
Parameter	Symbol	Test Condition	Min	Typ	Max	Unit
Maximum Reverse Leakage Current	I_{rm}	$V_r = 30\text{ V}$		0.004	0.100	mA
		$V_r = 30\text{ V}, T_J = 100^\circ\text{C}$		0.7	10	
		$V_r = -30\text{ V}, T_J = 125^\circ\text{C}$		3.0	20	
Junction Capacitance	C_T	$V_r = 10\text{ V}$		50		pF

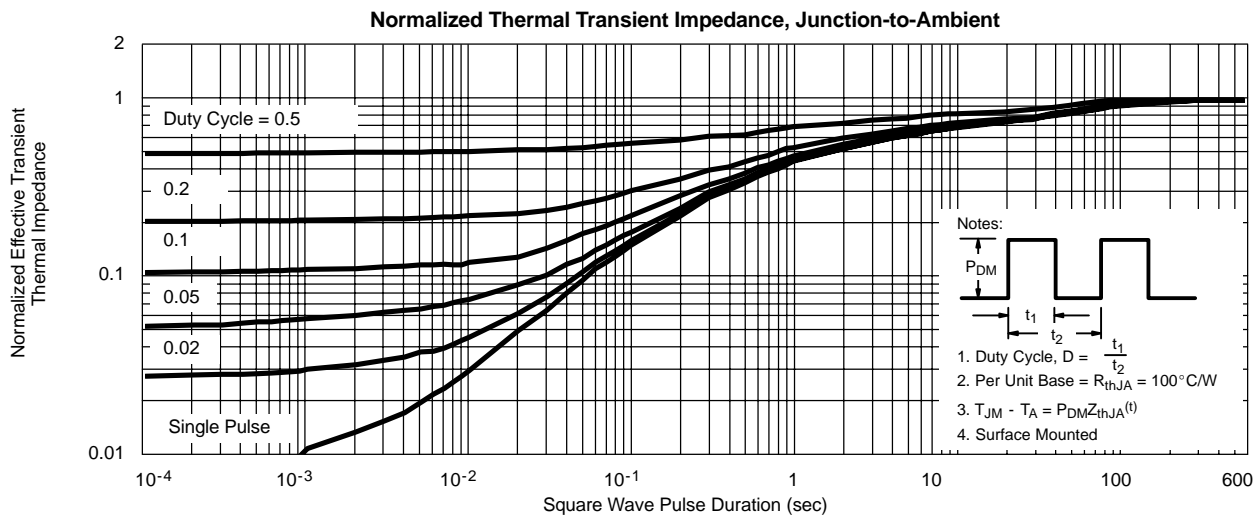
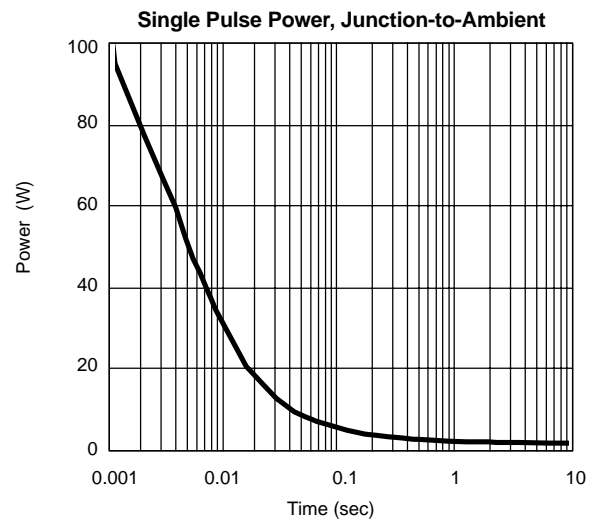
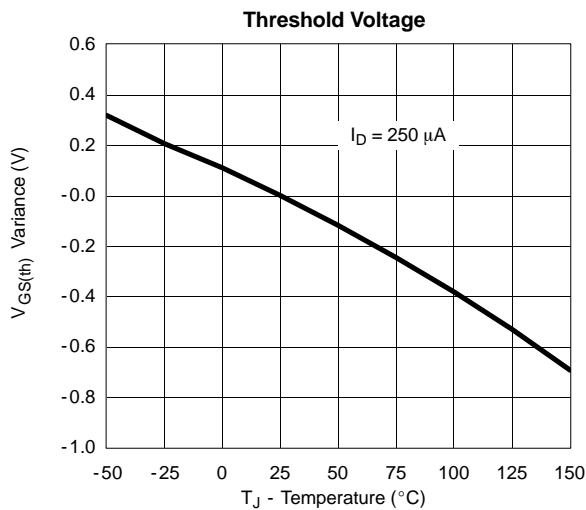
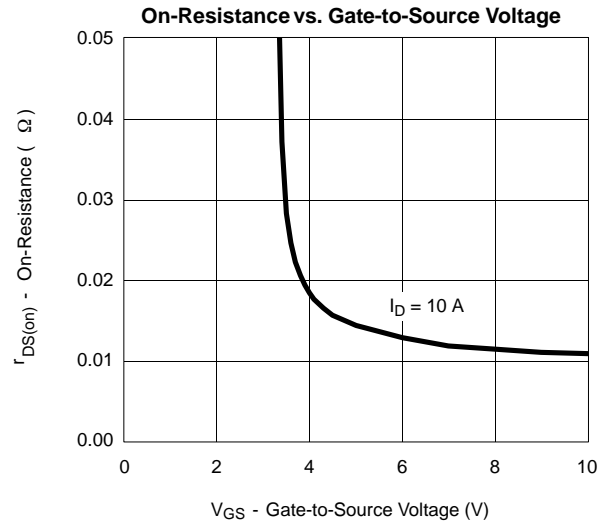
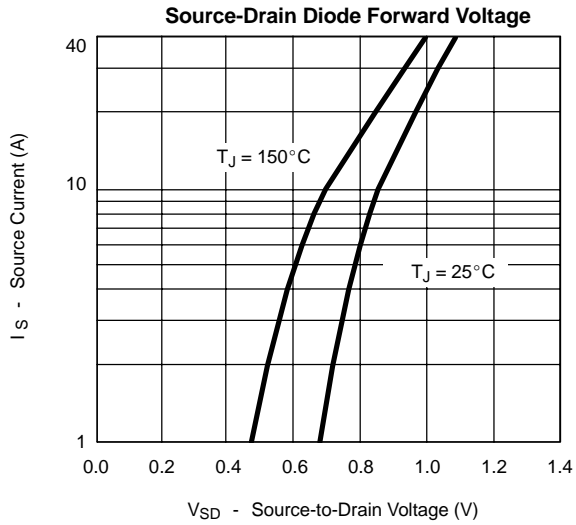
TYPICAL CHARACTERISTICS (25 °C UNLESS NOTED)

CHANNEL-1



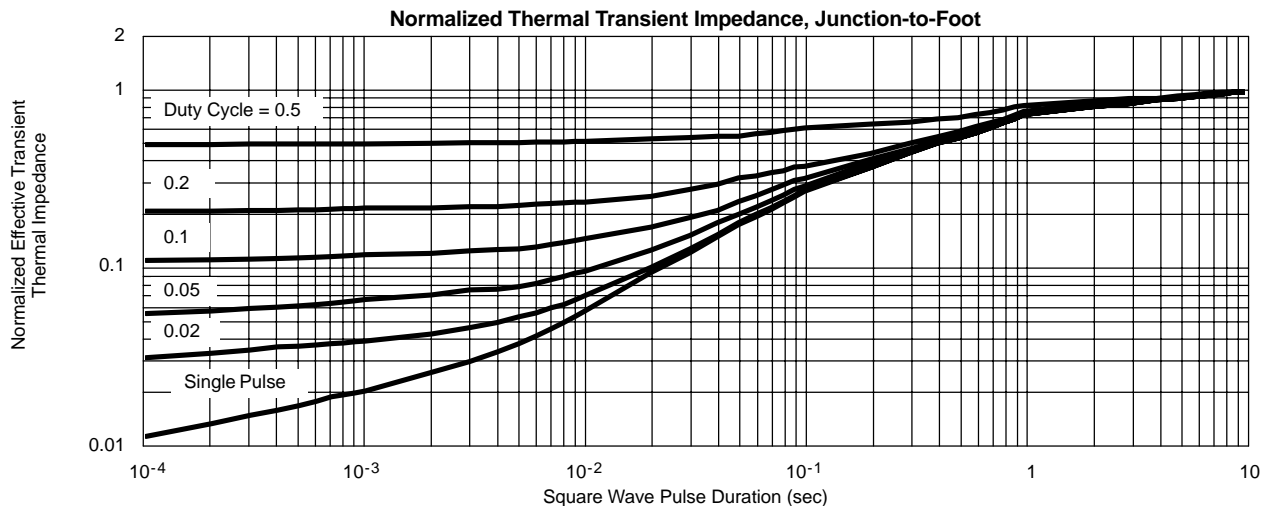


TYPICAL CHARACTERISTICS (25°C UNLESS NOTED) CHANNEL-1



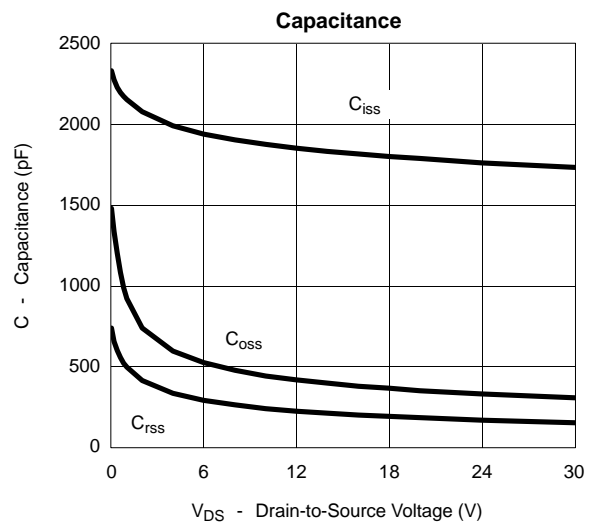
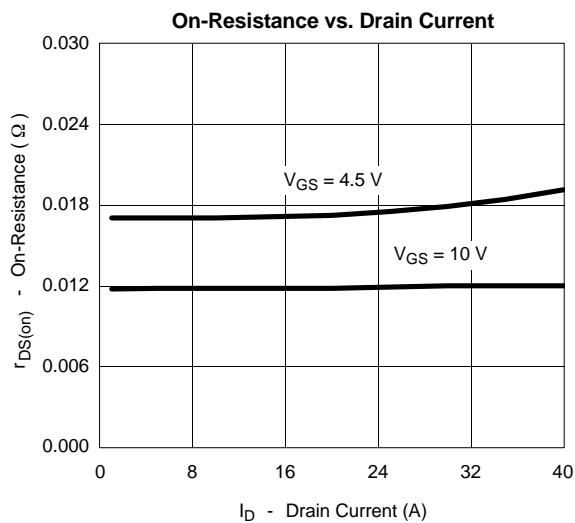
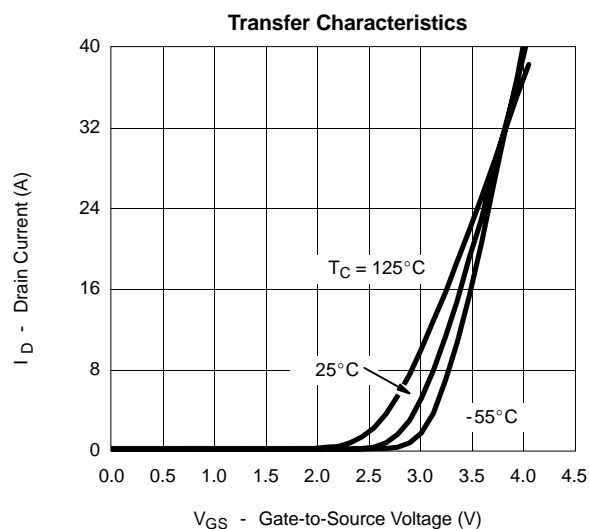
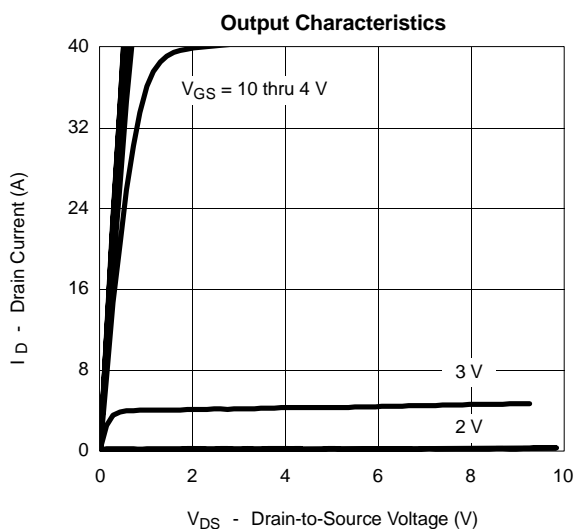
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CHANNEL-1



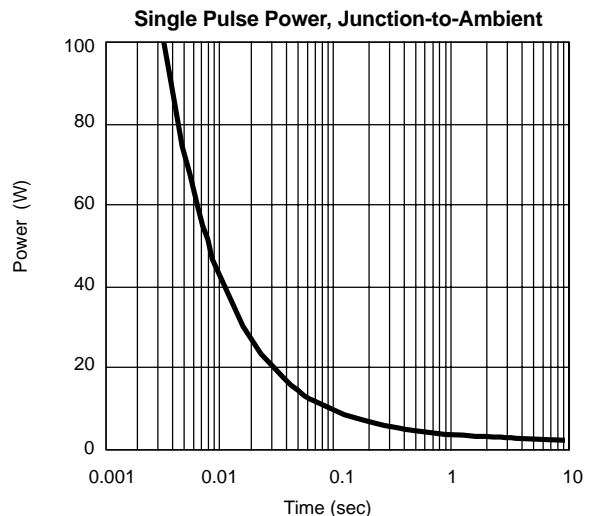
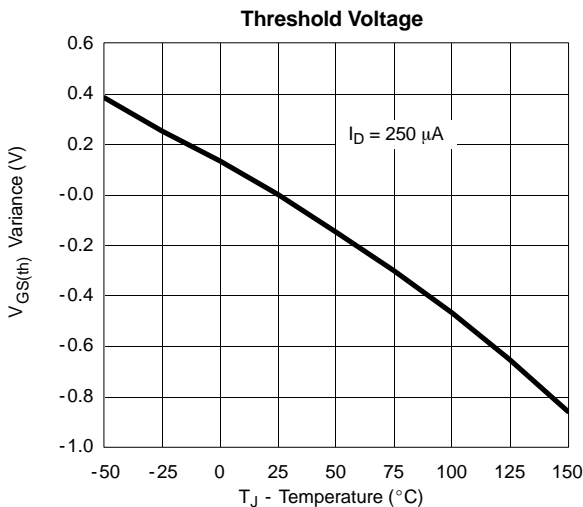
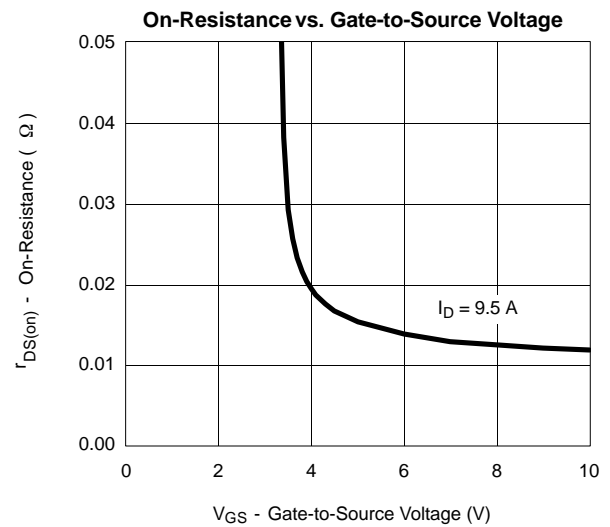
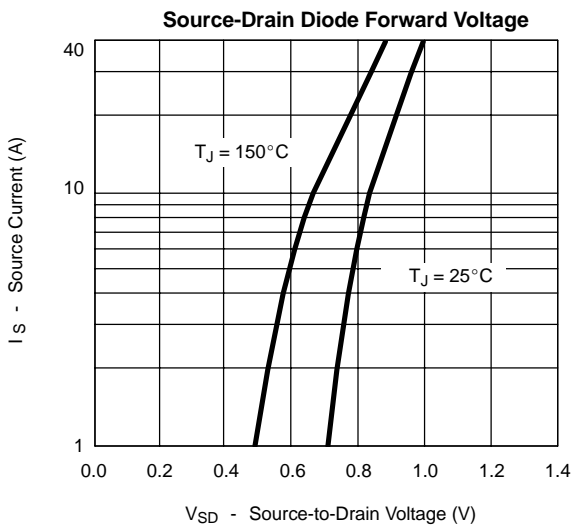
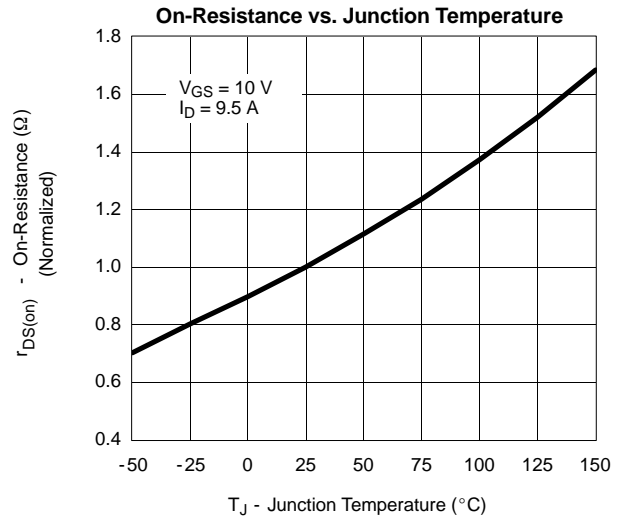
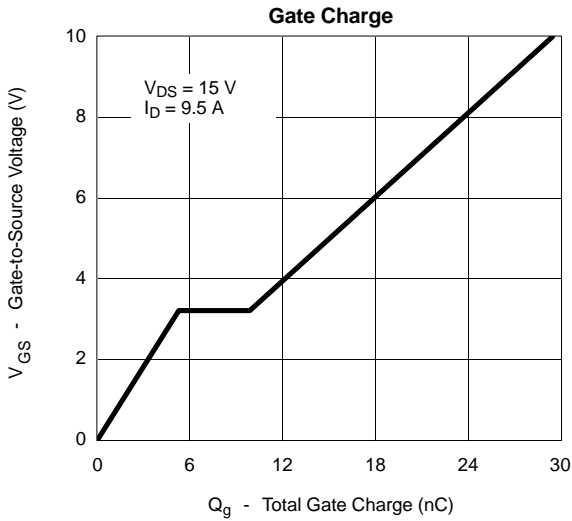
TYPICAL CHARACTERISTICS (25 °C UNLESS NOTED)

CHANNEL-2



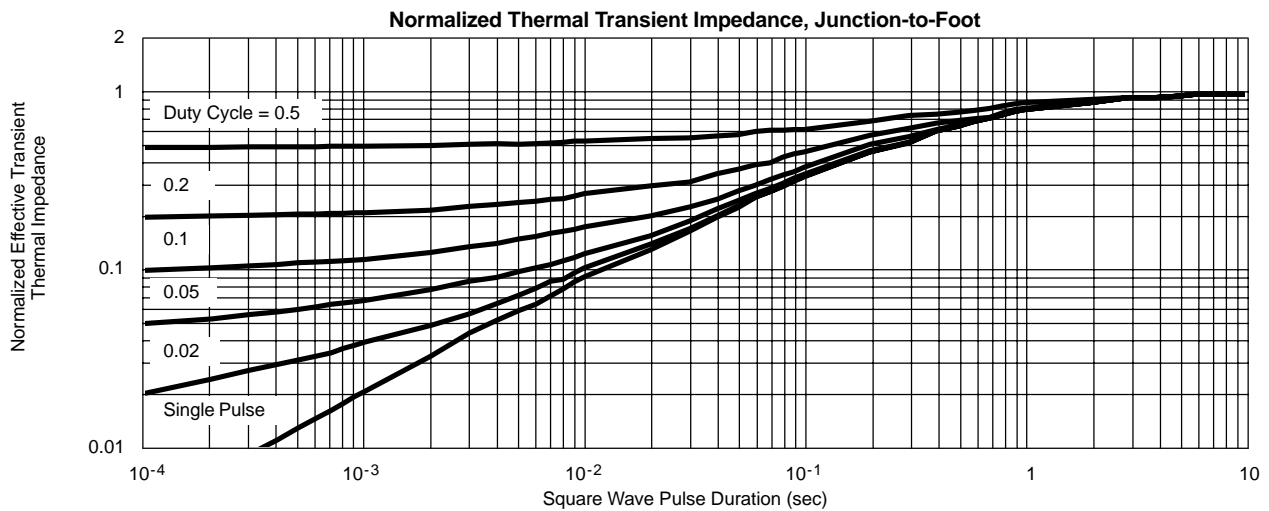
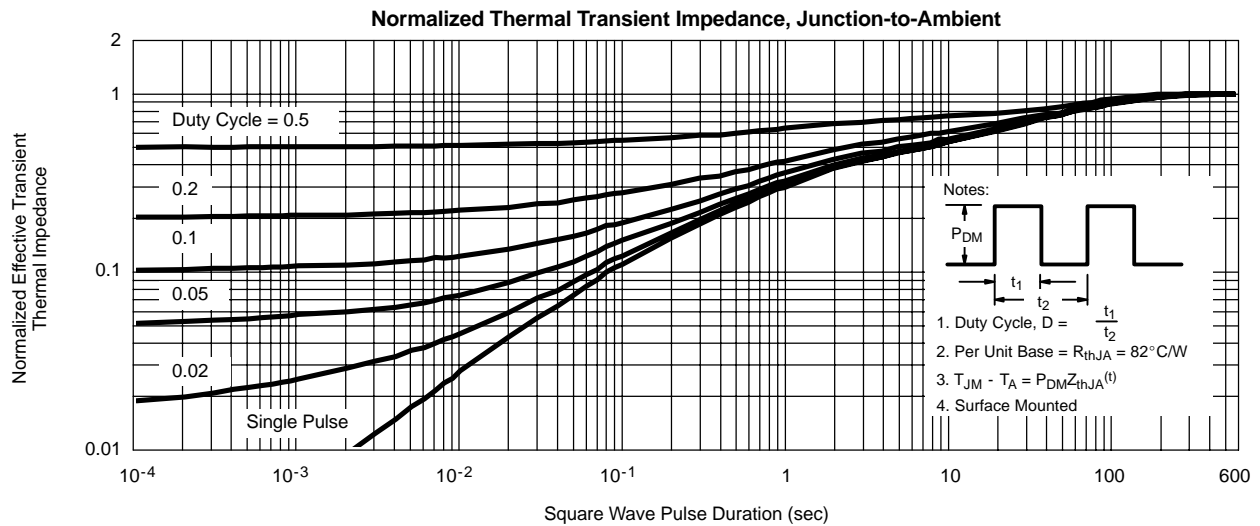


TYPICAL CHARACTERISTICS (25°C UNLESS NOTED) CHANNEL-2



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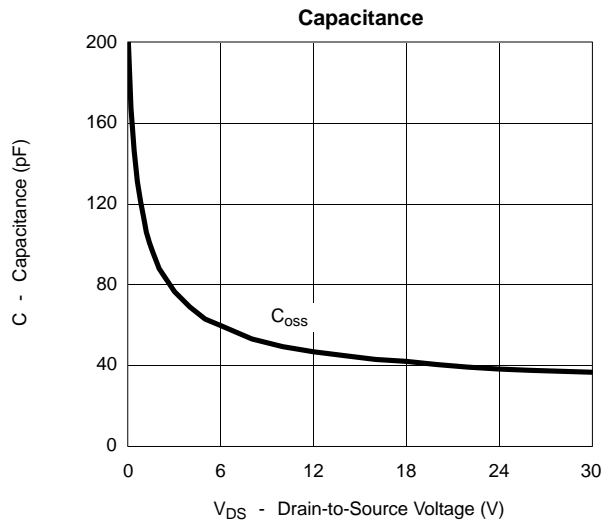
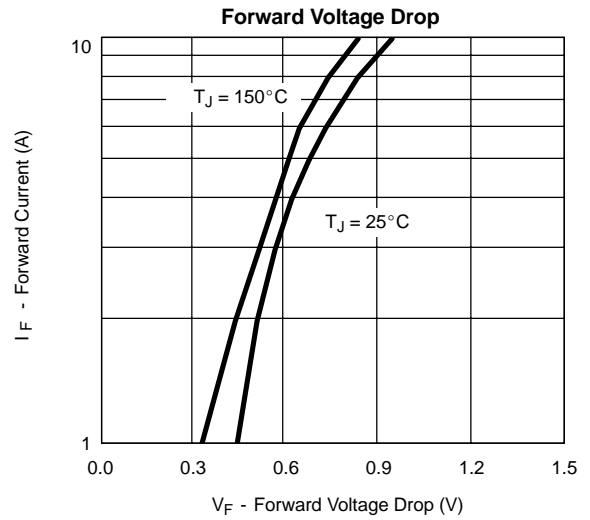
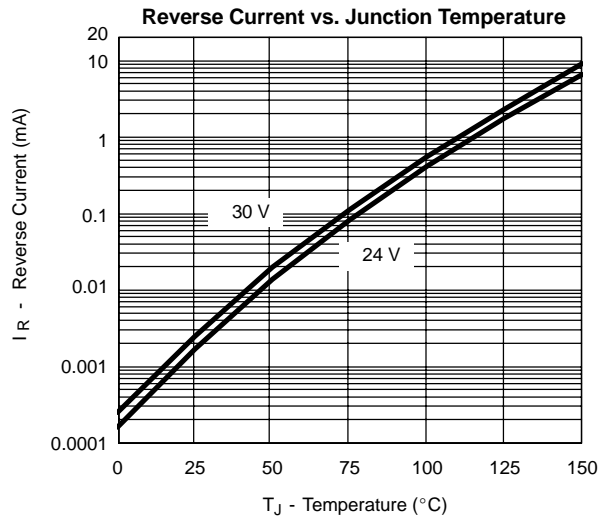
CHANNEL-2





TYPICAL CHARACTERISTICS (25°C UNLESS NOTED)

SCHOTTKY



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